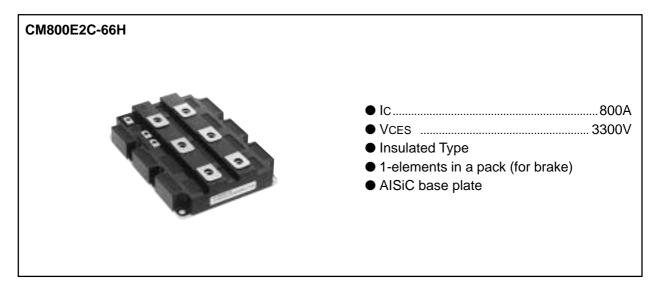
MITSUBISHI HVIGBT MODULES

CM800E2C-66H

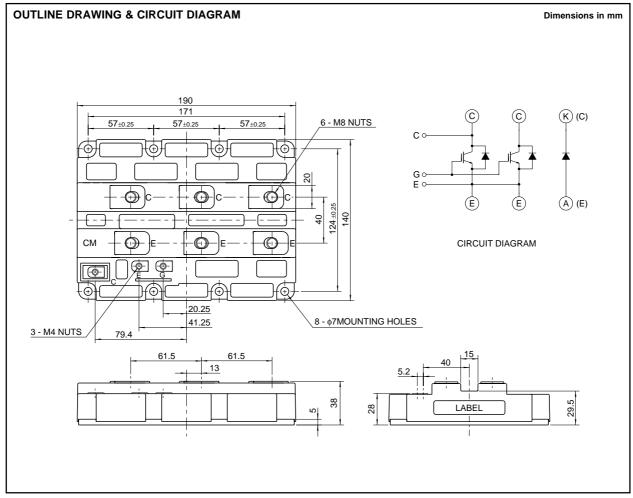
HIGH POWER SWITCHING USE
INSULATED TYPE

2nd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules



APPLICATION

DC choppers, Dynamic braking choppers.



HVIGBT MODULES (High Voltage Insulated Gate Bipolar Transistor Modules)



CM800E2C-66H

HIGH POWER SWITCHING USE INSULATED TYPE

2nd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

MAXIMUM RATINGS (Tj = 25°C)

Symbol	Item	Conditions	Ratings	Unit
VCES	Collector-emitter voltage	VGE = 0V	3300	V
VGES	Gate-emitter voltage	VCE = 0V	±20	V
Ic	Collector current	DC, Tc = 95°C	800	Α
Ісм	Collector current	Pulse (Note	e 1) 1600	Α
IE (Note 2)	Emitter current		800	Α
IEM (Note 2)	Emilier current	Pulse (Note	e 1) 1600	Α
PC (Note 3)	Maximum collector dissipation	Tc = 25°C, IGBT part	9600	W
Tj	Junction temperature	_	−40 ~ +150	°C
Tstg	Storage temperature	_	−40 ~ +125	°C
Viso	Isolation voltage	Charged part to base plate, rms, sinusoidal, AC 60Hz 1n	nin. 6000	V
_	Mounting torque	Main terminals screw M8	6.67 ~ 13.00	N⋅m
		Mounting screw M6	2.84 ~ 6.00	N⋅m
		Auxiliary terminals screw M4	0.88 ~ 2.00	N⋅m
_	Mass	Typical value	1.5	kg

ELECTRICAL CHARACTERISTICS (Tj = 25°C)

Symbol	Item	Conditions		Limits			L I a la
				Min	Тур	Max	Unit
ICES	Collector cutoff current	VCE = VCES, VGE = 0V			_	10	mA
VGE(th)	Gate-emitter	IC = 80mA, VCE = 10V		4.5	6.0	7.5	V
	threshold voltage						
IGES	Gate-leakage current	VGE = VGES, VCE = 0V			_	0.5	μΑ
V05(1)	Collector-emitter	Tj = 25°C	IO 8004 Vor 15V (Note 4)	_	3.80	4.94	V
VCE(sat)	saturation voltage	Tj = 125°C	IC = 800A, VGE = 15V (Note 4)	_	4.00	_	
Cies	Input capacitance	VCE = 10V VGE = 0V		_	120		nF
Coes	Output capacitance			_	12.0	_	nF
Cres	Reverse transfer capacitance			_	3.6	_	nF
QG	Total gate charge	Vcc = 1650V, Ic = 800A, VGE = 15V			5.7	_	μС
td (on)	Turn-on delay time	Vcc = 1650V, Ic = 800A		_	_	1.60	μs
tr	Turn-on rise time	VGE1 = VGE2 = 15V		_	_	2.00	μs
td (off)	Turn-off delay time	$RG = 2.5\Omega$			_	2.50	μs
tf	Turn-off fall time	Resistive load switching operation			_	1.00	μs
VEC (Note 2)	Emitter-collector voltage	IE = 800A, VGE = 0V			2.80	3.64	V
trr (Note 2)	Reverse recovery time	IE = 800A			_	1.40	μs
Qrr (Note 2)	Reverse recovery charge	die / dt = -1600A / μs			270	_	μС
Rth(j-c)Q	The second as a sistence of	Junction to case, IGBT part		_	_	0.013	K/W
Rth(j-c)R	Thermal resistance	Junction to case, FWDi part		_	_	0.025	K/W
Rth(c-f)	Contact thermal resistance	Case to fin, conductive grease applied (Per 2/3 module)			0.008	_	K/W
VFM	Forward voltage	IF = 800A, Clamp diode part			3.00	3.90	V
trr	Reverse recovery time	IF = 800A			_	1.40	μs
Qrr	Reverse recovery charge	dif / dt = -1600A / μs, Clamp diode part			270	_	μC
Rth(j-c)	Thermal resistance	Junction to case, Clamp diode part			_	0.025	K/W
Rth(c-f)	Contact thermal resistance	Case to fin, conductive grease applied (Per 1/3 module)			0.008		K/W

Note 1. Pulse width and repetition rate should be such that the device junction temp. (Tj) does not exceed Tjmax rating.

2. IE, VEC, tr, Qrr & die/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode.

3. Junction temperature (Tj) should not increase beyond 150°C.

4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

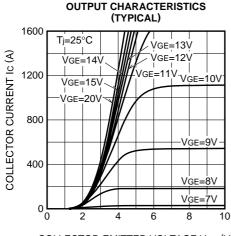


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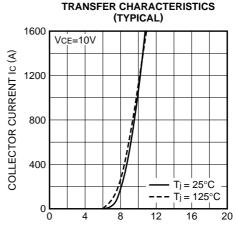
HIGH POWER SWITCHING USE INSULATED TYPE

PERFORMANCE CURVES

COLLECTOR-EMITTER SATURATION VOLTAGE VCE(sat) (V)

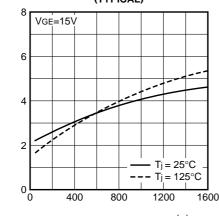


COLLECTOR-EMITTER VOLTAGE VCE (V)



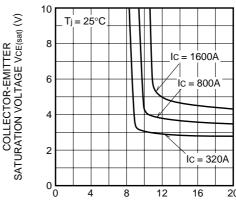
GATE-EMITTER VOLTAGE VGE (V)

COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



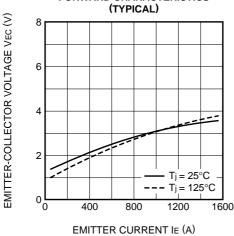
COLLECTOR CURRENT IC (A)

COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)

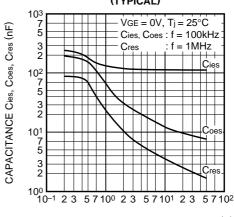


GATE-EMITTER VOLTAGE VGE (V)

FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



CAPACITANCE CHARACTERISTICS (TYPICAL)

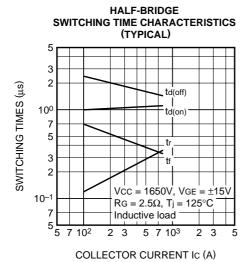


COLLECTOR-EMITTER VOLTAGE VCE (V)

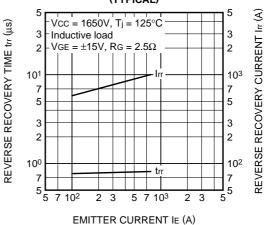
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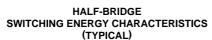
HIGH POWER SWITCHING USE INSULATED TYPE

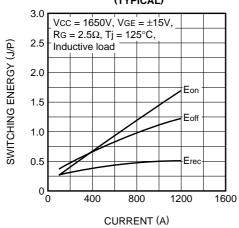
2nd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules



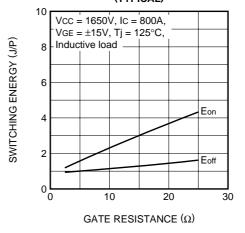
REVERSE RECOVERY CHARACTERISTICS OF FREE-WHEEL DIODE (TYPICAL) 5 Vcc = 1650V, Tj = 125°C



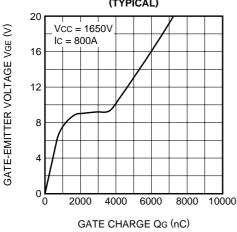




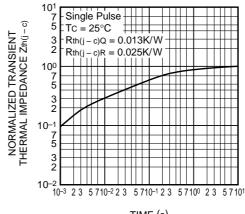
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



GATE CHARGE CHARACTERISTICS (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



TIME (s)

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